

Title (en)  
CIRCUIT

Title (de)  
SCHALTUNGSANORDNUNG

Title (fr)  
CIRCUIT

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Application  
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Abstract (en)  
[origin: WO02054492A2] The invention relates to a circuit comprising a first substrate (1) which has an integrated circuit (4) in a first surface (3) and a second surface (2) opposite the same, and a second substrate (9) which has a sensor (7) on one surface. Said second substrate (9) is adhesively connected to the first substrate (1) in such a way that the surface of the second substrate (9) comprising the sensor (7) faces one of the two surfaces (2, 3) of the first substrate (1). It can thus be determined whether the arrangement consisting of the first and second substrate is divided or has been divided.  
[origin: WO02054492A2] According to the invention, a sensor arrangement is to be formed on a second substrate, said sensor arrangement being arranged opposite a surface of a first substrate. It can thus be determined whether the arrangement consisting of the first and second substrate is divided or has been divided.

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